



# **Technical Specification** for

# **Small Form Factor Pluggable (SFP)**

SCP69K1-GL-##-xx (No Diagnostic Monitoring) SCP6EK1-GL-##-xx (Diagnostic Monitoring with External Calibration)

155.52Mbps	622.08Mbps		other	
Short Haul Intermediate Reach	Long Haul Long Reach		other	Link Budget 34dB
Single 5.0 V	Single 3.3 V		other	
1.3 µm	1.55 µm		other	CWDM
W / Diagnostic Monitor	W/O Diagnostic Mon	itor		

#### Applicable Part Numbers:

SCP69K1-GL-AN-xx, SCP69K1-GL-BN-xx, SCP69K1-GL-CN-xx, SCP69K1-GL-XN-xx, SCP69K1-GL-YN-xx, SCP69K1-GL-ZN-xx SCP6EK1-GL-AN-xx, SCP6EK1-GL-BN-xx, SCP6EK1-GL-CN-xx, SCP6EK1-GL-XN-xx, SCP6EK1-GL-YN-xx, SCP6EK1-GL-ZN-xx SCP69K1-GL-AM-xx, SCP69K1-GL-BM-xx, SCP69K1-GL-CM-xx, SCP69K1-GL-XM-xx, SCP69K1-GL-YM-xx, SCP69K1-GL-ZM-xx SCP6EK1-GL-AM-xx, SCP6EK1-GL-BM-xx, SCP6EK1-GL-CM-xx, SCP6EK1-GL-XM-xx, SCP6EK1-GL-YM-xx, SCP6EK1-GL-ZM-xx

xx:Wavelength 27: 1270nm, 29: 1290nm, 31: 1310nm, 33: 1330nm, 35: 1350nm, 37: 1370nm, 39: 1390nm, 41: 1410nm, 43: 1430nm, 45: 1450nm, 47: 1470nm, 49: 1490nm, 51: 1510nm, 53: 1530nm 55: 1550nm, 57: 1570nm, 59: 1590nm, 61: 1610nm

# SUMITOMO ELECTRIC

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#Safety Precaution Symbols This specification uses various picture symbols to prevent possible injury to operator or other persons or damage to properties for appropriate use of the product. The symbols and definitions are as shown below. Be sure to be familiar with these symbols before reading this specification.

	Wrong operation without following this instruction may lead to human death or serious injury.
	Wrong operation without following this instruction may lead to human injury or property damage.
Example of picture sym	bols indicates prohibition of actions. Action details are explained thereafter.

indicates compulsory actions or instructions. Action details are explained thereafter.

#### 1. General

Features and applications of SCP69K1-GL and SCP6EK1-GL are listed below.

#### **Features**

- \* 18 wavelengths CWDM Transceivers
- \* Uncooled CWDM rated DFB laser transmitter
- \* Compliant with SFP MSA.
- \* SFF-8472 rev.9 compliant diagnostic monitoring implemented. (SCP6EK1-GL-##-xx)

\* Power Supply voltage Single 3.3V

\* Compact package size 56.5 x 13.7 x 8.6mm

\* Electrical Interface AC coupled for DATA, LVTTL for Tx Disable and open collector output for

LOS and Tx Fault. Circuit ground is internally isolated from frame ground.

\* Fiber Coupled Power 0 to +5dBm \* Input Power Range -34 to -3dBm

\* Link budget 34dB

\* Alarm and Warning Flags (SCP6EK1-GL-##-xx)

#### **Applications**

\* Metropolitan Area Network

## 2. Block Diagram

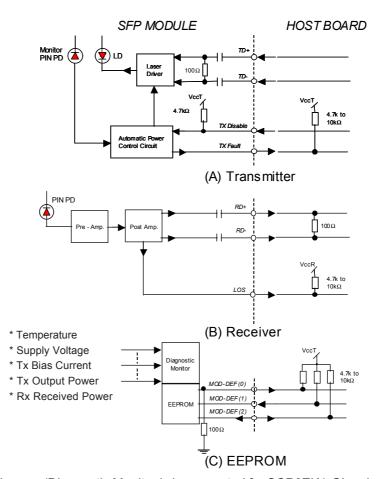


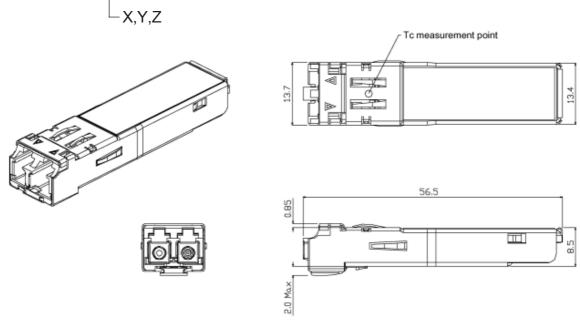
Figure 1. Block Diagram (Diagnostic Monitor is incorporated for SCP6EK1-GL only.)



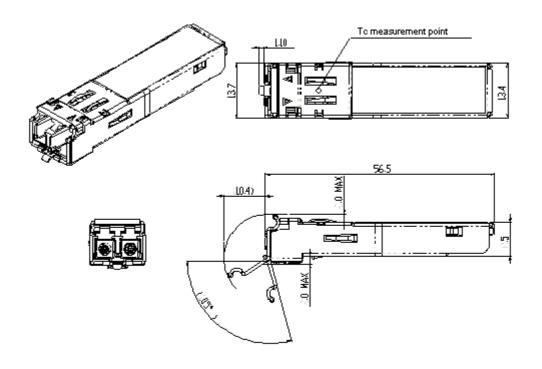
# 3. Package Dimensions

#### All dimensions are in mm.

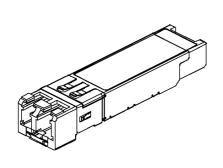
# 3.1 SCP6#K1-GL- N-xx (MSA Standard Actuator Type)

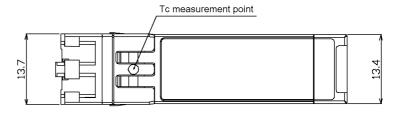


# 3.2 SCP6#K1-GL- N-xx (Bail Actuator Type)

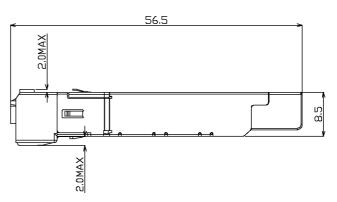


# 

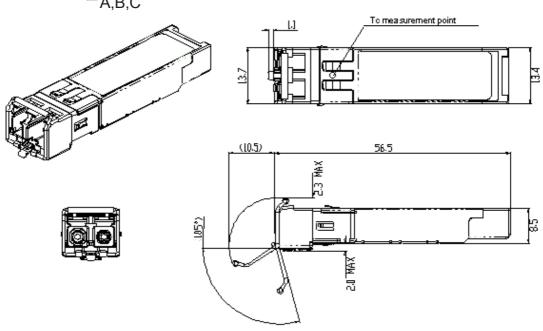








# 3.4 SCP6#K1-GL- M-xx (Bail Actuator Type)



\* Recommended Cage and Connector

-Top EMI Cage
-Bottom EMI Cage
-Host Connector
-Top EMI Cage
-Host Connector
-

Figure 2. Outline Dimensions

# 4. Pin Assignment

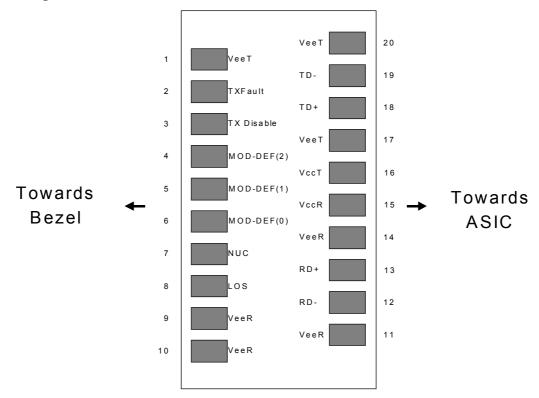


Figure 3. Diagram of Host Board Connector Block Pin Numbers and Names

Pin Num.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault	3	
		Indication		Note 1
3	TX Disable	Transmitter Disable	3	Note 2
				Module disables on high or open
4	MOD-DEF2	Module Definition 2	3	Note 3, 2 wire serial ID and Interface
5	MOD-DEF1	Module Definition 1	3	Note 3, 2 wire serial ID and Interface
6	MOD-DEF0	Module Definition 0	3	Note 3 Grounded internally via $100\Omega$
7	NUC	NUC	3	No User Connection,
				reserved for future function.
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver Ground	1	
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Receiver Data Out	3	Note 5
13	RD+	Receiver Data Out	3	Note 5
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	3.3V± 5%
16	VccT	Transmitter Power	2	3.3V± 5%
17	VeeT	Transmitter Ground	1	
18	TD+	Transmitter Data In	3	Note 6
19	TD-	Inv. Transmitter Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

Plug Seq.: Pin engagement sequence during hot plugging.

#### Note

Tx Fault is an open collector output that shall be pulled up with a 4.7k - 10kΩ resistor on the host board. Pull
up voltage between 2.0V and VccT+0.3V. When high, output indicates a laser fault of some kind. Low
indicates normal operation.

Tx Fault is asserted when bias current of laser exceeds the factory-calibrated threshold level.

- 2) Tx Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7k\Omega$  resistor.
- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a  $4.7k 10k\Omega$  resistor on the host board. The pull-up voltage shall be VccT.

Mod-Def 0 indicates that the module is present

Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

- 4) LOS (Loss of Signal) is an open collector output that shall be pulled up with a  $4.7k 10k\Omega$  resistor. Pull up voltage between 2.0V and VccR+0.3V. Low indicates normal operation.
- 5) RD-/+: These are the differential receiver outputs. They are AC coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board.
- 6) TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board.

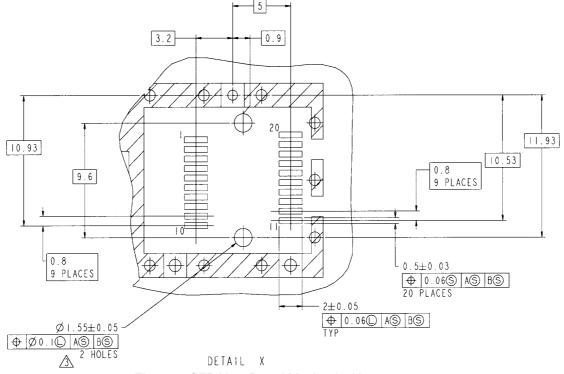


Figure 4. SFP Host Board Mechanical Layout

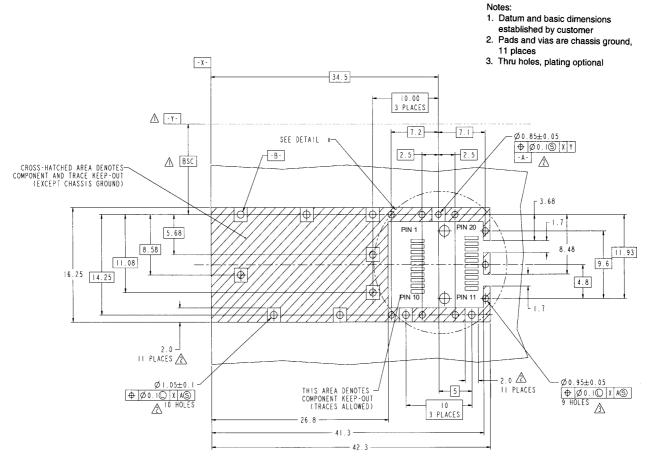
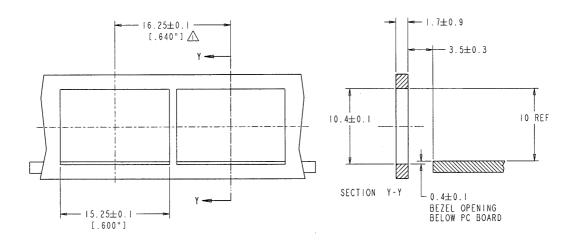


Figure 5. SFP Host Board Mechanical Layout (Cont.)



#### NOTES:

 $\stackrel{\textstyle \frown}{\bigtriangleup}$  MINIMUM PITCH ILLUSTRATED, ENGLISH DIMENSIONS ARE FOR REFERENCE ONLY

2. NOT RECOMMENDED FOR PCI EXPANSION CARD APPLICATIONS

Figure 6. Recommended Bezel Design

## 5. Absolute Maximum Ratings

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Storage Ambient Temperature	Ts	-40		85		1
Operating Case Temperature	Tc	-5		70	°C	2
Operating Case Temperature	10	-5		85		3
Optical Damage Input Level	Pin			3.0	dBm	
Supply Voltage	VccT,R	0		4.0	V	
Input Voltage	Vi	0		VccT+0.3	V	4
Differential Input Voltage Swing (TD+,TD-)	Vin			2.5	Vp-p	

#### Notes

1. No condensation allowed. 2. SCP6#K1-GL-#N-xx. 3. SCP6#K1-GL-#M-xx. 4. For MOD-DEF (1:2), Tx Disable.

# 



Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

# 



Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

#### 6. Electrical Interface

(Unless otherwise specified, VccT,R = 3.135 to 3.465 V and all operating temperature shall apply.)

#### 6-1. Operating Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply Voltage	V ccT,R	3.135	3.30	3.465	V	
Pow er Dissipation	Pw			1000	mW	1

Note 1.155.52Mbps, PRBS 2^23-1, NRZ, 50% duty cycle data.

#### 6-2. Transmitter side

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Differential Input Voltage	Sw ing (TD+,TD-)	Vin	0.3		2.4	Vp-p	1
Input Differential Impedance		Zin	80	100	120	Ω	
Tx Fault	Fault	VfaultH	2.0		VccT+0.3	V	2, 3
	Normal	VfaultL	0		0.8	V	2, 3, 4
Tx Disable	Dis able	Vdi	2.0		VccT	V	5
	Enable	Vei	0		0.80	V	3
Tdis Input Current	•	ldi	-1		50	μΑ	

#### Notes

- 1. Refer to Figure 7.
- 2. Tx Fault is pulled up to VccT with a 4.7k  $10k\Omega$  resistor on the host board.
  - When high, output indicates a laser fault of some kind. Low indicates normal operation.
- 3. Refer to P.12 about Tx Fault and Tx Shutdown behavior.
- 4. Sink Current: 1mA
- 5. Tx Disable input is internally terminated to VccT via 4.7  $k\Omega$  resistor. If pin3 is left open, Tx is disabled.

#### 6-3. Receiver side

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
Differential Output Voltage Sv	ving (RD+,RD-)	Vout	0.5		1.2	Vp-p	1
LOS	High	Vloh	2.0		VccR+0.3	V	2
Output Voltage	Low	VIol	0		0.8	V	2, 3
Data Rise / Fall Time		tr / tf			1.5	ns	4

#### Notes

- 1. Vcc=+3.3V+/-5%, Output load resistance Rdif=100 $\Omega$ . Refer to Figure1-(B). Refer to Figure7. about definition of differential sw ing.
- 2. LOS is pulled up to VccRw ith a 4.7k  $10k\Omega$  resistor on the host board. Low indicates normal operation.
- 3. Sink Current: 1mA, 4. 20 to 80%, 155.52Mbps, PRBS 2^23-1, NRZ, 50% duty cycle data

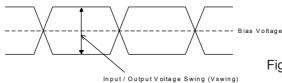


Figure 7. Definition of Differential

Differential Input / Output Voltage Swing (Vin / Vout) =  $2 \times Vswing$ 

Input / Output Voltage Swing

#### 6-4. Module Definition

Parameter		Symbol	Min.	Тур.	Max.	Unit	Note
MOD_DEF(1:2)	High	Vih	0.7VccT		VccT+0.3	V	1
Input Voltage	Low	Vil	0		0.3VccT	V	
MOD_DEF(2)	High	Voh	2.0		VccT	V	1
Output Voltage	Low	Vol1	0		0.4	V	1, 2

Notes

#### 7. Optical Interface

(Unless otherwise specified, VccT,R = 3.135 to 3.465 V and all operating temperature shall apply.)

#### 7-1. Transmitter side

Parameter	Symbol	Min.	Тур	Max.	Units	Notes
Average Output Power (Enable)	Po	0	-	5	dBm	
Average Output Power (Disable)	Pdis	-	-	-45	dBm	
Extinction Rate	Er	10.0	-	-	dB	
	λc (27)	1264.5	1270	1277.5	nm	
	λc (29)	1284.5	1290	1297.5	nm	
	λc (31)	1304.5	1310	1317.5	nm	
	λc (33)	1324.5	1330	1337.5	nm	
	λc (35)	1344.5	1350	1357.5	nm	
	λc (37)	1364.5	1370	1377.5	nm	
	λc (39)	1384.5	1390	1397.5	nm	
	λc (41)	1404.5	1410	1417.5	nm	7 I
Center Wavelength	λc (43)	1424.5	1430	1437.5	nm	<b>□</b> 1
	λc (45)	1444.5	1450	1457.5	nm	T '
	λc (47)	1464.5	1470	1477.5	nm	
	λc (49)	1484.5	1490	1497.5	nm	
	λc (51)	1504.5	1510	1517.5	nm	
	λc (53)	1524.5	1530	1537.5	nm	
	λc (55)	1544.5	1550	1557.5	nm	
	λc (57)	1564.5	1570	1577.5	nm	
	λc (59)	1584.5	1590	1597.5	nm	
	λc (61)	1604.5	1610	1617.5	nm	
Spectral w idth	Δλ	-	-	1	nm	
Side Mode Suppression Ratio		30	-	-	dB	
Eye Mask for Optical Output	Con	npliant with Telc	ordia GR-253 C	ORE and ITU-T G	957	
Jitter Generation	Tjpk	1	-	0.07	Ulp-p	2
Jiller Generation	Tjrms	-	-	0.007	Ulrms	7 ′
Optical Path Penarty		-	-	1	dB	3

#### Notes

Worst case extinction ratio. Measured at 155.52Mbps, PRBS 2<sup>2</sup>3-1, NRZ.
 Maximum dispersion values correspond to the approximate w orst-case dispersion (to 1600ps/nm)

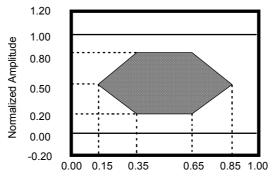


Figure 8. Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

# **⚠** Warning

Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

<sup>1.</sup> They shall be pulled up to VccT with a 4.7k - 10kW resistor on the host board. 2. Sink Current : 3mA

<sup>1.</sup> Measured at 155.52Mbps, PRBS 2^23-1, 50% duty cycle, NRZ.

<sup>2.</sup> SONET OC-3c data pattern filled with a 2^23-1 PRBS payload.

Measured with a bandpass filter having a high-pass cutoff freguency of 12kHz and a low -pass cutoff freguency of 1.3MHz.

Specification: TS-S03D185E

March, 2005

# 7-2. Receiver side

Parameter	Symbol	Min.	Тур	Max	Units	Notes
Center Wavelength	-	1260	-	1620	nm	
Minimum Sensitivity	Pmin	-	-	-34.0	dBm	1,2
Overload	Pmax	-3.0	-	-	dBm	1,2
LOS Activation Level	P <sub>La</sub>	-45.0	-	-34.5	dBm	
LOS Deactivation Level	P <sub>Ld</sub>	-44.5	-	-34.0	dBm	2
LOS Hysteresis	Phys	0.5	-	6.0	dB	
Reflectance	REFr	-	-37.0	-27.0	dB	

Notes

<sup>1.</sup> BER =  $10^{-10}$  2. Worst case extinction ratio. Measured at 155.52Mbps, PRBS  $2^{23-1}$ , NRZ.

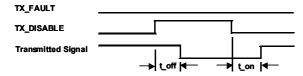
March, 2005

## 7-3. Transceiver Timing Characteristics

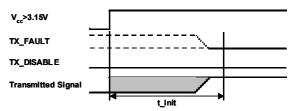
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Tx Disable Assert Time	t_off			10	us	1
Tx Disable Negate Time	t_on			1	ms	2
Time to Initialize	t_init			300	ms	3
Tx Fault Assert Time	t_fault			100	us	4
Tx Disable to Reset	t_reset	10			us	5
LOS Assert Time	t_loss_on	2.3		100	us	6
LOS Deas sert Time	t_loss_off			100	us	7
Serial ID Clock Rate	f_serial_clock			100	kHz	

#### Notes

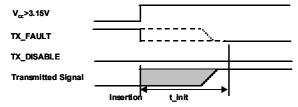
- 1. Time from rising edge of TX Disable to when the optical output falls below 10% of nominal.
- 2. Time from falling edge of TX Disable to when the modulated optical output rises above 90% of nominal.
- 3. From power on or negation of TX Fault using TX Disable. 4. Time from fault to TX fault on.
- 5. Time TX Disable must be held high to reset TX\_fault.
- 6. Time from LOS state to RXLOS assert. 7. Time from non-LOS state to RXLOS deassert.



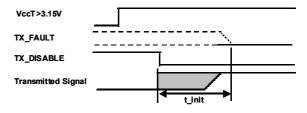
TX\_DISABLE timing during normal operation.



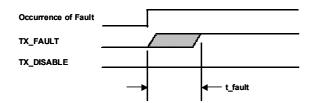
Power on initialization of SFP transceiver, TX\_DISABLE negated



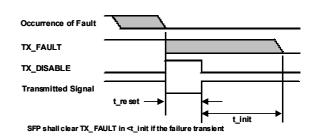
Example of initialization during hot plugging, TX\_DISABLE negated



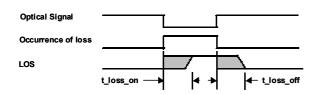
Power on initialization of SFP,TX\_DISABLE asserted



Detection of transmitter safety fault condition



Successful recovery from transient safety fault condition (Except for Type "B" and "Y". Refer to next page.)



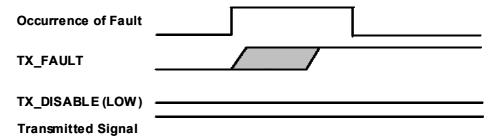
Timing of LOS detection

### 7-4. Tx\_Fault / Tx Shutdown Options

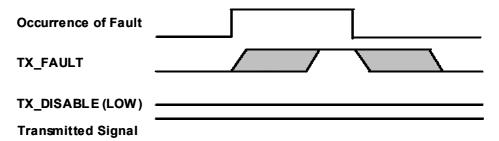
SCP69K1-GL- #-xx
SCP6EK1-GL- #-xx
Actuator and Tx\_Fault Type

Type	Actuator	Tx Fault	Tx Shutdown on Tx Fault
Α	Bail	Latched	No
В	Bail	Not Latched	No
С	Bail	Latched	Yes
Χ	MSA	Latched	Yes
Υ	MSA	Not Latched	No
Z	MSA	Latched	No

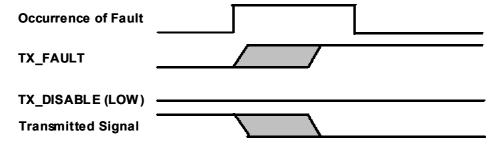
Type:"A" or "Z"



Type:"B" or "Y"



Type:"C" or "X"



# 8. Digital Diagnostic Memory Map

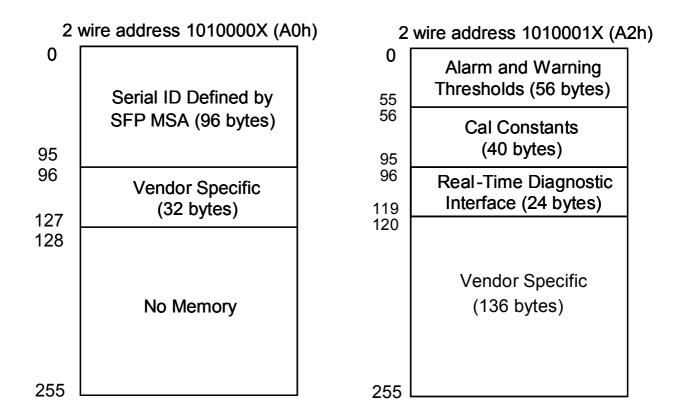


Figure 11. Digital Diagnostic Memory Map (A2h is applicable for SCP6EK1-GL-##-xx)

# 9. EEPROM Serial ID Memory Contents

The data can be read using the 2-wire serial CMOS EEPROM protocol of the Atmel AT24C01A or equivalent.

2 wire address 1010000X (A0h)

Transcalver	Add=====	Name of State	Шах	AC CII	Description	Add==	Name of field	lu <sub>ov</sub>	AS CII	Description
Benefier   03	Address	Name of field			Description	Address	Name of field			Description
Ext Identifier   04	n	Identifier		LDS	CED Transacius	64			J 3	1
Comedor   O7	1				SEP Transceiver		Options			
Transceiver	<u>1</u>				I C Campagian		DD may			
Section   Control   Cont	2	Connector			LC Connector					
Month   Mont	<u>3</u>	+					BR, MIN	00		Veer
Transceiver	<del>4</del> 5	_	0.4		OC3/LR-2		4		-	
Tarkselver   00		+					+			IVIOTIUI
1	<u>6</u>	Transceiver					4		-	
00	<u>/</u>						4			
0	8	_					4		-	
1	9	1					4			
2   38 R. Nominal   02   155 52Mbps   76   16   16   16   16   16   16   16	10	- "			CONET Constitution		4			
The property is a control of the property i							Vendor SN	Note4		
Lenth(Sum)					155.52NIDPS		+			
Fear					001		4		-	
Engith (50 um)   00	14				80km		4			
Reserved   00   00   00   00   00   00   00							4			
Base							4		-	
Reserved							4	l	<b> </b>	<u> </u>
Sa   Sa   Sa   Sa   Sa   Sa   Sa   Sa							4	l	<b></b>	
12	19	Reserved		0			-		ļ	
Section   Sect	20	1		8			4	l	<u> </u>	
69	21	4	75	-			4	l		
Section   Sect	22	4		m			4	l		
Section   Sect	23	1		i			Date code	Note5		
Section   Sect	24			t			Date code	110100		
Fraction   Fraction	25			-			1			
1	26	1		m						
Second   Fig.   Fig.	27	Vandar nama		0		91				
Second   S	28	vendor name		E		92	Diagnostic Monitoring Type			
11	29			1		32	Diagnostic Montoning Type			
11	30		65	е		0.2	CEE 9473 Compliance	B0(Note6)		Diagnostics
Teach   Teac	31		63	С		93				Non-diagnostics
12	32		74	t		0.4				Diagnostics
Reserved   O	33		72	r			· ·	00		Non-diagnostics
Reserved   O	34		69	į		95	CC EXT	Note7		
Reserved   O	35		63	С			VENDOR SPE	CIFIC ID F	IELDS	•
18	36	Reserved	00			96				
99   100	37		00			97	1	20		
99   100	38	Vendor OUI	00			98	1	20		
10	39					99	7	20		
1	40			S			1			
102   103   104   105   105   106   107   106   107   107   107   108   109	41	1	43	C			†			
36   6   6   39   Non-diagnostics   104   105   105   106   107   108   107   108   107   108   109   107   108   109   107   108   109   107   108   109	42	1	50				1			
39   9   Non-diagnostics   45   E   Diagnostics(Ext.Cal)   105	43			6			1			
45   E   Diagnostics(Ext.Cal)   105   106   107   108   108   109   108   109   109   108   109   10		1			Non-diagnostics		1			İ
AB	44						1			İ
107   107   108   109	45	1	4B		gou.o(LAt.ou.)		†			i e
10	46	†	31				1		i	
109   109	47	Vendor PN		-			†		1	
4C	48	1		G			†		l	
2D		†		ı			†			
Al to 43, 58 to 5A   A to C, X to Z   Actuator and Tx Fault Type   4E or 4D   N or M   2D   113   114   2D   115   116   115   116   116   116   116   116   117   118   119	50	†	2D	-			†			
AE or 4D		†		Λ to C V to 7	Actuator and Tr. Cault Tr.		Read-only			
2D	52	†	4F or 4D		Actuator and TX_Fault Type		1		<del>                                     </del>	<del> </del>
32,33,34,35,36   2,3,4,5,6   Wavelength   115   20	53	†					1			
116   20		†		22156			4		-	
110   117   120   118   120   117   120   118   120   118   120		+		∠,3,4,3,0 1 2 E 7 0	Wavelength		1		ļ	<del></del>
118   20   20   20   20   20   20   20   2		-		1,3,5,7,9	-		+		<del>                                     </del>	-
119   20   120	<u>56</u>	+		A TO Z	variable	11/	4		<b> </b>	<del>                                     </del>
119   20   20     20   20   20     20   20     20		Vendor rev					4		<b> </b>	
121   20     122   20     122   20     123   123   123   124   125   126   125   126   1	58						4			
122   20     123     124     125     126     126     126     126     127     128	59		20				4		ļ	
122   20   123   124   20   125   126   126   126   126   126   126   127   127   128	60	Wavelength	Note2				1			
3   CC_BASE   Note3   124   20   125   20   126   20   126   20   126   126   126   127   128	61	_				122	1			
125 126 20	62						1			
126 20	63	CC_BASE	Note3				1			
							1			
127 20						100	1	00		

Note1. Fiber Loss 0.35dB/km. Fiber loss budget plus all other syst em penalties must not exceed total system budget specification.

Note2. The laser wavelength is equal to the 16 bit integer value in nm.

Note7. Address 95 is check sum of bytes 64 - 94.

<sup>1470</sup>nm: 5BEh, 1490nm: 5D2h, 1510nm: 5E6h, 1530nm: 5FAh, 1550nm: 60Eh, 1570nm: 62h, 1590nm: 636h,1610nm: 64Ah

Note3. Address 63 is check sum of bytes 0 - 62. Note4. Address 68 - 83 is Vendor serial Number.

Note5. Address 84 - 91 is Date Code. Note6. Refer to Section 10.( Enhanced Monitoring Functions )

# 10. Enhanced Monitoring Functions (SCP6EK1-GL-##-xx)

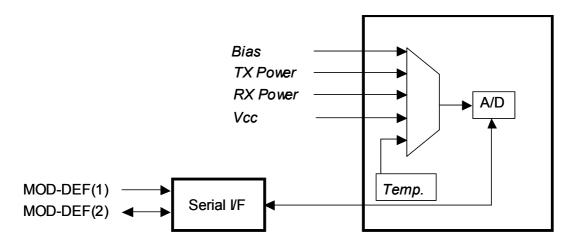


Figure 12. Block Diagram

#### Diagnostic Monitoring Type, 2 wire address A0h

Data Address	Bits	Description	Status(SEI)
92	7	Reserved for legacy diagnostic	0
		implementations. Must be '0' for compilance with SFF-8472.	
92	6	Digital diagnostic monitoring implemented (described in SFF-8472). Must be '1' for compliance with SFF-8472.	1
92	5	Internally Calibrated	0
92	4	Externally Calibrated	1
92	3	Received power measurement type 0 = OMA, 1 = Average Power	1
92	2	Address change required. (Refer to SFF-8472)	0
92	1-0	Reserved	0

#### Enhanced Options, 2 wire address A0h

Data Address	Bits	Description	Status(SEI)
93	7	Optional Alarm/warning flags implemented for	1
		all monitored quantities	
93	6	Optional Soft TX_DISABLE control and	0
		monitoring implemented	
93	5	Optional Soft TX_FAULT monitoring	1
		implemented	
93	4	Optional Soft RX_LOS monitoring	1
		implemented	
93	3	Optional Soft RATE_SELECT control and	0
		monitoring implemented	
93	2-0	Reserved	0

## 11. Calibration Calculation (SCP6EK1-GL-##-xx)

Calibration constants for External Calibration Option, 2 wire address A2h

Address	#Bytes	Name	Description
56-59	4	$RP_{\!\scriptscriptstyle 4}$	Single precision floating-point calibration data for
		7	received power. Byte 56 is MSB. Byte 59 is LSB.
60-63	4	RP <sub>3</sub>	Single precision floating-point calibration data for
		Ü	received power. Byte 60 is MSB. Byte 63 is LSB.
64-67	4	$RP_2$	Single precision floating-point calibration data for
		_	received power. Byte 64 is MSB. Byte 67 is LSB.
68-71	4	$RP_1$	Single precision floating-point calibration data for
		·	received power. Byte 68 is MSB. Byte 71 is LSB.
72-75	4	$RP_0$	Single precision floating-point calibration data for
		-	received power. Byte 72 is MSB. Byte 75 is LSB.
76-77	2	I <sub>SLOPE</sub>	Unsigned fixed-point calibration data for laser bias
			current. Byte 76 is MSB. Byte 77 is LSB.
78-79	2	I <sub>OFFSET</sub>	16-bit signed 2's complement calibration data for laser
			bias current. Byte 78 is MSB. Byte 79 is LSB.
80-81	2	TP <sub>SLOPE</sub>	Unsigned fixed-point calibration data for laser output
			power. Byte 80 is MSB. Byte 81 is LSB.
82-83	2	TP <sub>OFFSET</sub>	16-bit signed 2's complement calibration data for laser
			output power. Byte 82 is MSB. Byte 83 is LSB.
84-85	2	$T_{SLOPE}$	Unsigned fixed-point calibration data for transceiver
			temperature. Byte 84 is MSB. Byte 85 is LSB.
86-87	2	T <sub>OFFSET</sub>	16-bit signed 2's complement calibration data for
			transceiver temperature. Byte 86 is MSB. Byte 87 is LSB.
88-89	2	$V_{SLOPE}$	Unsigned fixed-point calibration data for supply voltage.
			Byte 88 is MSB. Byte 89 is LSB.
90-91	2	$V_{OFFSET}$	16-bit signed 2's complement calibration data for supply
			voltage. Byte 90 is MSB. Byte 91 is LSB.
92-94	3	Reserved	
95	1	Checksum	Byte 95 contains the low order 8 bits of the sum at data
			address bytes 0-94.

#### Transceiver temperature: Temperature, T, is given by

$$T = T_{SLOPE} * T_{AD} + T_{OFFSET}$$

Where  $T_{AD}$  is 16-bit signed 2's complement A/D value at bytes 96-97,  $T_{SLOPE}$  is unsigned fixed-point value at bytes 84-85 and  $T_{OFFSET}$  is signed 2's complement value with LSB equal to 1/256 deg-C at bytes 86-87. The result, T, is 16-bit signed 2's complement value with LSB equal to 1/256 deg-C. The monitored output is the junction temperature of the diode inside the transceiver, hence, there is some discrepancy between the output and transceiver case temperature of the point illustrated in section 3 mechanical dimension.

#### Supply voltage: Voltage, V, is given by

$$V = V_{SLOPE} * V_{AD} + V_{OFFSET}$$

Where  $V_{AD}$  is 16-bit unsigned A/D value at bytes 98-99,  $V_{SLOPE}$  is unsigned fixed-point value at bytes 88-89 and  $V_{OFFSET}$  is signed 2's complement value with LSB equal to 100  $\mu$ V at bytes 90-91. The result, V, is 16-bit unsigned value with LSB equal to 100  $\mu$ V.

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Laser bias current: Current, I, is given by

$$| = |_{SLOPE} * |_{AD} + |_{OFFSET}$$

Where  $I_{AD}$  is 16-bit unsigned A/D value at bytes 100-101,  $I_{SLOPE}$  is unsigned fixed-point value at bytes 76-77 and  $I_{OFFSET}$  is signed 2's complement value with LSB equal to 2  $\mu$ A at bytes 78-79. The result, I, is 16-bit unsigned value with LSB equal to 2  $\mu$ A.

Laser output power: Power, TP, is given by

$$\mathsf{TP} = \mathsf{TP}_{\mathsf{SLOPE}} * \mathsf{TP}_{\mathsf{AD}} + \mathsf{TP}_{\mathsf{OFFSET}}$$

Where  $TP_{AD}$  is 16-bit unsigned A/D value at bytes 102-103,  $TP_{SLOPE}$  is unsigned fixed-point value at bytes 80-81 and  $TP_{OFFSET}$  is signed 2's complement value with LSB equal to 0.1  $\mu$ W at bytes 82-83. The result, TP, is 16-bit unsigned value with LSB equal to 0.1  $\mu$ W.

**Received power**: Power, RP, is given by RP = RP<sub>4</sub> \* RP<sub>AD</sub> 
$$^4$$
 + RP<sub>3</sub> \* RP<sub>AD</sub>  $^3$  + RP<sub>2</sub> \* RP<sub>AD</sub>  $^2$  + RP<sub>1</sub> \* RP<sub>AD</sub> + RP<sub>0</sub>

Where RP $_{AD}$  is 16-bit unsigned A/D value at bytes 104-105 and RP $_{4}$ , RP $_{3}$ , RP $_{2}$ , RP $_{1}$  and RP $_{0}$  are single precision floating-point values at bytes 56-75. The result, RP, is 16-bit unsigned value with LSB equal to 0.1  $\mu$ W.

A/D Accuracy, 2 wire address A2h

Data Address	Parameter	Accuracy	Units Display	Note
96-97	Temperature	+/-3 deg-C	Signed 2's complement integer deg-C	Junction temperature of monitoring IC.
98-99	Vcc	+/-3%	x100µVolt	
100-101	TX Bias	+/-10%	x2μA	Specified by nominal value
102-103	TX Power	+/-3dB	x0.1µW	0 to +5dBm
104-105	RX Power	+/-3dB ( -34 to -10dBm )	x0.1μW	At specified transmitter wavelength ( Section 7-1 )

# 12. A/D Values and Status (SCP6EK1-GL-##-xx)

#### Converted analog values, 2wire address A2h

Byte	Bit	Name	Description
96	All	Temperature MSB	Signed 2's complement integer temperature(-40 to +125C)
			Based on internal temperature measurement
97	All	Temperature LSB	Fractional part of temperature(count/256)
98	All	Vcc MSB	Internally measured supply voltage in transeciver.
99	All	Vcc LSB	Actual voltage is full 16 bit value *100uVolt.(Yields
			range of 0-6.55V)
100	All	TX Bias MSB	Measured Laser Bias Current in mA. Bias current is full
101	All	TX Bias LSB	16 bit value *2μA.(Full range of 0-131mA)
102	All	TX Power MSB	Measured TX output power in mW. TX power is full 16
103	All	TX Power LSB	bit value*0.1μW.(Full range of -40 to+8.2dBm)
104	All	RX Power MSB	Measured RX input power in mW. RX power is full 16
105	All	RX Power LSB	bit value*0.1μW.(Full range of -40 to+8.2dBm)
106-109	All	Reserved	

#### Optional Status Bits, 2wire address A2h

Byte	Bit	Name	Description
110	0	Data_Ready_Bar	Indicates transceiver has achieved power up and data is
		·	ready. Bit remains high until data is ready to be read at
			which time the device sets the bit low.

# 13. Alarm and Warning Flags (SCP6EK1-GL-##-xx)

#### Alarm and Warning Flags, 2wire address A2h

Byte	Bit	Name	Description
112	7	Temp High Alarm	Set when internal temperature exceeds high alarm level.
112	6	Temp Low Alarm	Set when internal temperature is below low alarm level.
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.
112		TX Power High Alarm	Set when TX output power exceeds high alarm level.
112		TX Power Low Alarm	Set when TX output power is below low alarm level.
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.
113		RX Power Low Alarm	Set when Received Power is below low alarm level.
113		Reserved	
114	All	Reserved	
115	All	Reserved	
116	7	Temp High Warning	Set when internal temperature exceeds high warning level.
116		Temp Low Warning	Set when internal temperature is below low warning level.
116		Vcc High Warning	Set when internal supply voltage exceeds high warning level.
116		Vcc Low Warning	Set when internal supply voltage is below low warning level.
116		TX Bias High Warning	Set when TX Bias current exceeds high warning level.
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.
116		TX Power High Warning	Set when TX output power exceeds high warning level.
116		TX Power Low Warning	Set when TX output power is below low warning level.
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.
117		RX Power Low Warning	Set when Received Power is below low warning level.
117	5-0	Reserved	
118	All	Reserved	
119	Αll	Reserved	

# 14. Recommended Interface Circuit

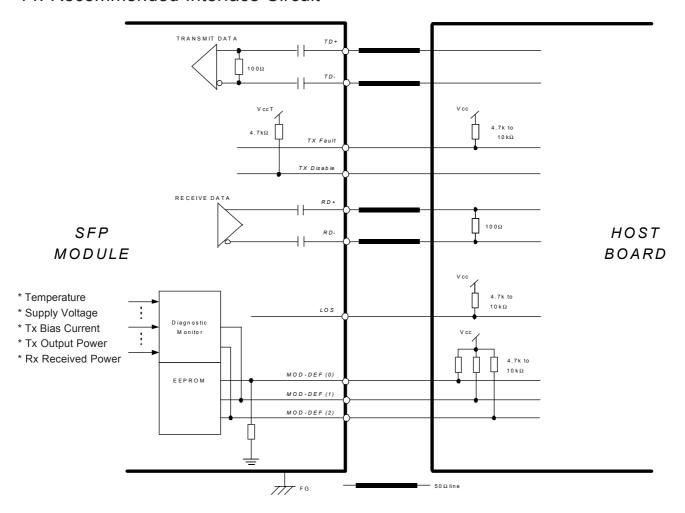


Figure 13. Recommended Interface Circuit (Diagnostic Monitor is incorporated for SCP6EK1-GL-##-xx only.)

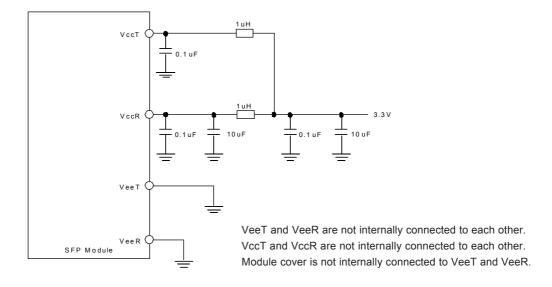


Figure 14. Recommended Supply Filtering Network

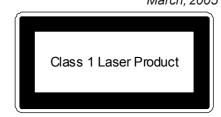
## 15. Laser Safety

This product uses a semiconductor laser system and the product with

Center Wavelength  $\lambda c(41)$  to  $\lambda c(61)$  is a laser class 1

product acceptable FDA, complies with 21CFR 1040. 10 and 1040.11.

Also this product is a laser class 1 product acceptable IEC 60825.



### **∧** Caution

 $\bigcirc$ 

If this product is used under conditions not recommended in the specification or this product is used with unauthorized revision, classfication for laser product safety standard is invalid. Classify the product again at your responsibility and take appropriate actions.

#### 16. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed. The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

# ⚠ Warning



Do not put this product or components of this product into your mouth. This product contains material harmful to health.

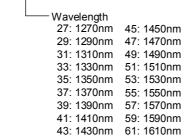
## ▲ Caution.



Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

## 17. Ordering Information

SCP6aK1-GL for de



**Operating Case Temperature** 

N: Tc=-5 to 70°C M: Tc=-5 to 85°C

### Actuator and Tx Fault Type

Туре	Actuator	Tx Fault	Tx Shutdow n on Tx Fault	Part Number on Label
Α	Bail	Latched	No	SCP6 aK1-GL-AC-de
В	Bail	Not Latched	No	SCP6aK1-GL-Bc-de
С	Bail	Latched	Yes	SCP6aK1-GL-Cc-de
Х	MSA	Latched	Yes	SCP6aK1-GL-XC-de
Υ	MSA	Not Latched	No	SCP6aK1-GL-YC-de
Z	MSA	Latched	No	SCP6aK1-GL-ZC-de

Diagnostic Monitor / Calibration type

9: No Diagnostic Monitoring

E: Diagnostic Monitoring with External Calibration

#### 18. Bail Color

wavelength	d e	Bail color
1270nm	27	Light purple
1290nm	29	Sky blue
1310nm	31	Yellow Green
1330nm	33	Yellow Ocher
1350nm	35	Pink
1370nm	37	Beige
1390nm	39	white
1410nm	41	Silver
1430nm	43	Black
1450nm	45	Yellow Orange
1470nm	47	Gray
1490nm	49	Violet
1510nm	51	Blue
1530nm	53	Green
1550nm	55	Yellow
1570nm	57	Orange
1590nm	59	Red
1610nm	61	Brown

#### 19. For More Information

U.S.A.

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http://www.sei.co.jp/Electro-optic/index\_e.html

(SCP69K1/6EK1-GL)